

# Factory Programmable, Quad PLL Clock Generator with VCXO

## Features

- Fully integrated phase-locked loops (PLLs)
- Small quad flat no-leads (QFN) package option
  - 40% smaller than 20-pin TSSOP
  - 22% smaller than 16-pin TSSOP
- Selectable output frequency
- Programmable output frequencies
- Output frequency range:
  - 1 MHz to 166 MHz
- Input frequency range:
  - Crystal: 10 MHz to 30 MHz
  - External reference: 1 MHz to 100 MHz
- Analog voltage-control crystal oscillator (VCXO)
- 16-/20-pin TSSOP and 32-pin QFN packages
- 3.3-V operation with 2.5-V output buffer option

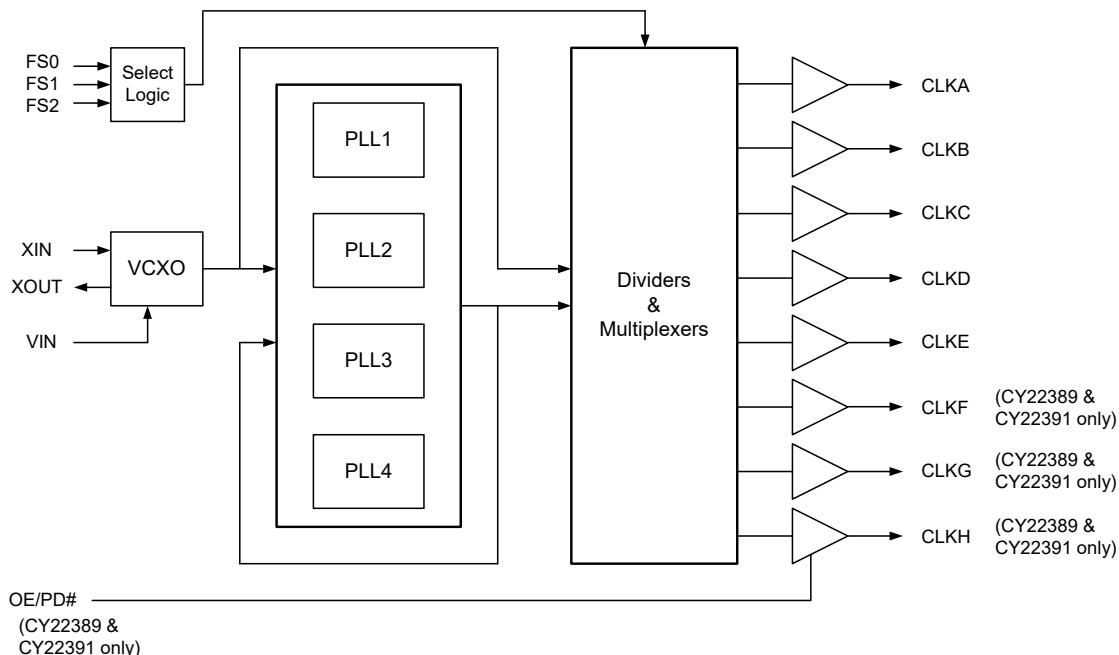
## Benefits

- Meets most digital set top box, DVD recorder, and DTV application requirements
- Multiple high-performance PLLs allow synthesis of unrelated frequencies
- Integration eliminates the need for external loop filter components
- Meets critical timing requirements in complex system designs
- Enables application compatibility
- Complete VCXO solution with  $\pm 120$  ppm (typical pull range)

## Functional Description

For a complete list of related documentation, click [here](#).

## Logic Block Diagram

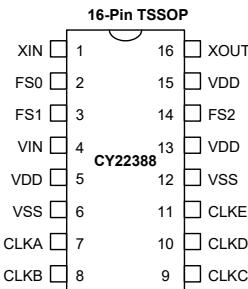


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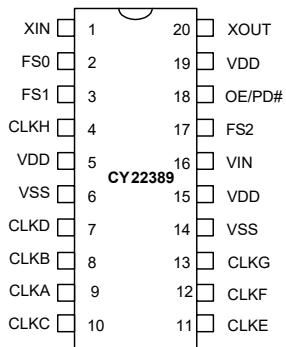
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## Pinouts

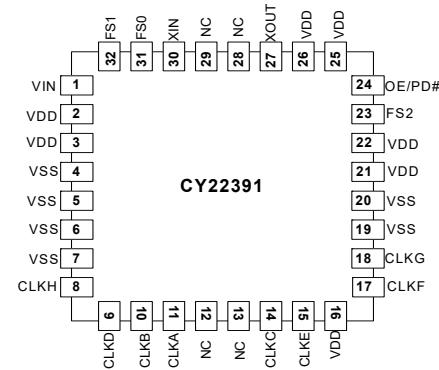
**Figure 1. 16-pin TSSOP pinout**



**Figure 2. 20-pin TSSOP pinout**



**Figure 3. 32-pin QFN pinout**



## Pin Definitions

| Pin Name | Pin Number   |              |                          | Pin Description  |
|----------|--------------|--------------|--------------------------|--|
|          | 16-pin TSSOP | 20-pin TSSOP | 32-pin QFN               |  |
| XIN      | 1            | 1            | 30                       | Crystal input or reference clock input   |
| XOUT     | 16           | 20           | 27                       | Crystal output (No connect if external clock is used)                            |
| CLKA     | 7            | 9            | 11                       | Clock output   |
| CLKB     | 8            | 8            | 10                       | Clock output   |
| CLKC     | 9            | 10           | 14                       | Clock output   |
| CLKD     | 10           | 7            | 9                        | Clock output   |
| CLKE     | 11           | 11           | 15                       | Clock output   |
| CLKF     | n/a          | 12           | 17                       | Clock output   |
| CLKG     | n/a          | 13           | 18                       | Clock output   |
| CLKH     | n/a          | 4            | 8                        | Clock output   |
| FS0      | 2            | 2            | 31                       | Frequency select 0   |
| FS1      | 3            | 3            | 32                       | Frequency select 1   |
| FS2      | 14           | 17           | 23                       | Frequency select 2   |
| OE/PD#   | n/a          | 18           | 24                       | Programmable control pin: Output enable (active-high) or power-down (active-low) |
| VIN      | 4            | 16           | 1                        | Analog control input for VCXO  |
| VDD      | 5, 13, 15    | 5, 15, 19    | 2, 3, 16, 21, 22, 25, 26 | Voltage supply   |
| VSS      | 6, 12        | 6, 14        | 4, 5, 6, 7, 19, 20       | Ground   |
| NC       | N/A          | N/A          | 12, 13, 28, 29           | No connect.  |

## General Description

The CY22388 family of devices has an analog VCXO, four PLLs, up to eight clock outputs and frequency selection capabilities. The frequency selects do not modify any PLL frequency. Instead they allow the user to choose among eight different output divider selections depending on the clock and package configuration. This is illustrated in [Frequency Select Pin Operation](#).

There is one programmable OE/PD#. The OE/PD# pin can be programmed as either an output enable pin or a power-down pin. The OE function can be programmed to disable a selected set of outputs when low, leaving the remaining outputs running. Full-chip power-down disables all outputs and the PLLs and most of the active circuitry when low.

## Factory-Programmable CY22388/89/91

Factory programming is available for high- or low-volume manufacturing by Cypress. All requests must be submitted to the local Cypress field application engineer (FAE) or sales representative. After the request is processed, you receive a new part number, samples, and datasheet with the programmed values. This part number is used for additional sample requests and production orders.

## PLLs

The advantage of having four PLLs is that a single device can generate up to four independent frequencies from a single crystal. Generally a design may require up to four oscillators to accomplish what could be done with a single CY22388.

Each PLL is independent and can be configured to generate a voltage-controlled oscillator (VCO) frequency between 62.5 MHz and 250 MHz. Each PLL can then, in turn, be divided down with post dividers to generate the clock output frequency of the user's choice. The output divider allows each clock output to be divided by 1, 2, 3, 4, 5, 6, 8, 9, 10, 12 or 15. The PLL maximum is reduced to 166 MHz in 'divide by 1' mode due to output buffer limitations.

Outputs that allow frequency switching perform a glitch-free transition. A glitch is defined as a high- or low-time shorter than half the smaller of the two periods being switched between. Extended low time (even many cycles in duration) is acceptable.

Selected clock outputs are capable of being powered off a separate 2.5-V supply. This allows for driving lower voltage swing inputs. The CY22388/89/91 device still requires 3.3 V to power the oscillator and all other internal PLL circuitry. For the 2.5-V output option, refer to the [CY22388 application note](#). Selected clocks and pinout diagrams are explained in this application note.

Clock D can obtain its output from either the reference source or PLL1/N1 with N1 being defined as the output divider for PLL1. Clock H is defined as a copy of clock D. Clock D is only available from PLL1/N1 on the 16-pin package.

For CY22388, CLKB and CLKC have related frequencies. For CY22389 and CY22391, CLKD and CLKF have related frequencies, CLKA and CLKB have related frequencies, and CLKC and CLKE have related frequencies. Related frequencies come from the same PLL but can have different divider values.

To minimize parts per million (PPM) error on the clock outputs, you must choose a crystal reference frequency that is a common multiple of the desired PLL frequencies. While this is the ideal situation, this is not always the case and the PLLs have high-resolution counters internally to help minimize frequency deviation from the desired frequency.

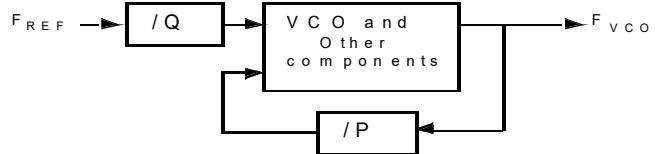
PLL VCO frequencies are generated by the following equation:

$$F_{VCO} = F_{REF} \times (P / Q)$$

where  $F_{REF}$  is the reference input frequency, P is the PLL feedback divider, and Q is the reference input divider.

A PLL is a feedback system where the VCO frequency divided by P and reference frequency divided by Q are constantly being compared and the VCO frequency is adjusted to achieve a locked state. [Figure 4](#) is a simplified drawing of a PLL.

**Figure 4. PLL system**



## Frequency Select Pin Operation

**Table 1. CY22388 16-pin TSSOP**

| Output Signal | Frequency Selection Lines |
|---------------|---------------------------|
| CLK A         | FS2, FS1, FS0             |
| CLK B         | FS1, FS0                  |
| CLK C & CLK D | S0                        |
| CLK E         | FIXED                     |

**Table 2. CY22389 20-pin TSSOP**

| Output Signal         | Frequency Selection Lines |
|-----------------------|---------------------------|
| CLK A                 | FS2, FS1, FS0             |
| CLK B & CLK C         | FS1, FS0                  |
| CLK D, CLK E, & CLK F | FS0                       |
| CLK G                 | FIXED                     |
| CLK H                 | COPY OF CLK D             |

**Table 3. CY22391 32-pin QFN**

| Output Signal         | Frequency Selection Lines |
|-----------------------|---------------------------|
| CLK A                 | FS2, FS1, FS0             |
| CLK B & CLK C         | FS1, FS0                  |
| CLK D, CLK E, & CLK F | FS0                       |
| CLK G                 | FIXED                     |
| CLK H                 | COPY OF CLK D             |

## Analog VCXO

There are three programmable reference operating modes for the CY22388, CY22389, and CY22391 family of devices. The first mode uses an external pullable crystal and incorporates an internal analog VCXO.

The second mode configures the internal crystal oscillator to accept an external driven reference source from 1 to 100 MHz. The input capacitance on the XIN PIN when driven in this mode is 15 pF.

The third mode disables the VCXO input control and sets the internal oscillator to a fixed frequency operation. The load capacitance seen by the external crystal when connected to PINS XIN and XOUT is equal to 12 pF.

One of the key components in the CY22388, CY22389, and CY22391 family of devices is the analog VCXO. The VCXO is used to 'pull' the reference crystal higher or lower to lock the system frequency to an external source. This is ideal for applications where the output frequency needs to track along with an external reference frequency that is constantly shifting.

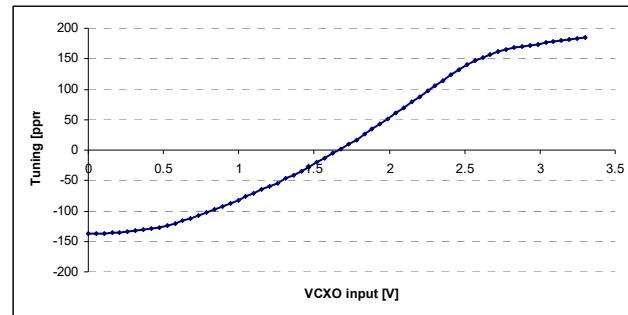
The VCXO is completely analog, so there is infinite resolution on the VCXO pull curve. The analog to digital converter steps that are normally associated with a digital VCXO input is not present in this device. A special pullable crystal must be used in order to

have adequate VCXO pull range. Pullable crystal specifications are included in this datasheet.

### VCXO Profile

**Figure 5** shows an example of what a VCXO profile looks like. The analog voltage input is on the X-axis and the PPM range is on the Y-axis. An increase in the VCXO input voltage results in a corresponding increase in the output frequency. This has the effect of moving the PPM from a negative to positive offset.

**Figure 5. VCXO Profile**



## Absolute Maximum Conditions

| Parameter                | Description   | Condition                | Min  | Max            | Unit |
|--------------------------|---|--------------------------|------|----------------|------|
| $V_{DD}/AV_{DD}/V_{DDL}$ | Core supply voltage   |                          | -0.5 | 4.6            | V    |
| $V_{IN}$                 | Input voltage   | Relative to $V_{SS}$     | -0.5 | $V_{DD} + 0.5$ | VDC  |
| $T_S$                    | Temperature, Storage  | Non-Functional           | -65  | 125            | °C   |
| $ESD_{HBM}$              | Electrostatic discharge (ESD) protection (human body model) | MIL-STD-883, Method 3015 | 2000 | -              | V    |
| UL-94                    | Flammability rating   | V-0 at 1/8 in.           | -    | 10             | ppm  |
| MSL                      | Moisture sensitivity level                                  | All packages             | 3    | -              |      |

## Pullable Crystal Specifications

| Parameter <sup>[1, 2]</sup> | Description                                       | Comments  | Min  | Typ        | Max  | Unit |
|-----------------------------|---|---|------|------------|------|------|
| $F_{NOM}$                   | 13.5-MHz and 27-MHz crystal AT-Cut                | Parallel resonance, fundamental mode                |      | See Note 2 |      |      |
| $C_{LNOM}$                  | Nominal load capacitance                          | Order crystal at one specific $C_{LNOM}$ 0 ppm      | 11.4 | 12         | 12.6 | pF   |
| $R_1$                       | Equivalent series resistance (ESR)                | Fundamental mode (CL = Series)                      | -    | -          | 40   | Ω    |
| DL                          | Crystal drive level                               | Nominal $V_{DD}$ at 25 °C over ±120 ppm pull range  | -    | -          | 300  | μW   |
| $C_0$ <sup>[3]</sup>        | Crystal shunt capacitance                         |   | 1.5  | 3          | 4.0  | pF   |
| $C_1$ <sup>[3]</sup>        | Crystal motional capacitance                      |   | 12   | 14         | 16.8 | fF   |
| $F_{3SEPHI}$ <sup>[2]</sup> | Third overtone separation from $3 \times F_{NOM}$ | Mechanical third (high side of $3 \times F_{NOM}$ ) | 240  | -          | -    | ppm  |
| $F_{3SEPLO}$ <sup>[2]</sup> | Third overtone separation from $3 \times F_{NOM}$ | Mechanical third (low side of $3 \times F_{NOM}$ )  | -    | -          | -120 | ppm  |

## Operating Conditions

| Parameter                | Description   | Min  | Typ | Max | Unit |
|--------------------------|---|------|-----|-----|------|
| $V_{DD}/AV_{DD}/V_{DDL}$ | Operating voltage   | 3.0  | 3.3 | 3.6 | V    |
| $T_A$                    | Ambient temperature   | -10  | -   | 70  | °C   |
| $C_{LOAD}$               | Maximum load capacitance  | -    | -   | 15  | pF   |
| $t_{PU}$                 | Power-up time for all $V_{DDs}$ reach minimum specified voltage (power ramps must be monotonic) | 0.05 | -   | 500 | ms   |

### Notes

1. Device operates to the following specs, which are guaranteed by design.
2. Refer to online software for a list of approved crystal specifications.
3. Increased tolerance available from pull range less than ±120 ppm.

## DC Parameters

| Parameter <sup>[4]</sup> | Description                  | Conditions  | Min                  | Typ | Max                  | Unit    |
|--------------------------|------------------------------|---|----------------------|-----|----------------------|---------|
| $I_{OH}^{[5]}$           | Output high current          | $V_{OH} = V_{DD} - 0.5$ , $V_{DD} = 3.3$ V                          | 12                   | –   | –                    | mA      |
| $I_{OL}^{[5]}$           | Output low current           | $V_{OL} = 0.5$ , $V_{DD} = 3.3$ V                                   | 12                   | –   | –                    | mA      |
| $I_{IH}$                 | Input high current           | $V_{IH} = V_{DD}$ , excluding $V_{in}$ , $X_{in}$                   | –                    | 5   | 10                   | $\mu$ A |
| $I_{IL}$                 | Input low current            | $V_{IL} = 0$ V, excluding $V_{in}$ , $X_{in}$                       | –                    | 5   | 10                   | $\mu$ A |
| $V_{IH}$                 | Input high voltage           | FS0/1/2 OE input CMOS levels  | $0.7 \times A_{VDD}$ | –   | –                    | V       |
| $V_{IL}$                 | Input low voltage            | FS0/1/2 OE input CMOS levels  | –                    | –   | $0.3 \times A_{VDD}$ | V       |
| $V_{VCXO}$               | VIN input range              | Internal setting in VCXO are XOB/A = 110, Offset = 1110, Gain = 101 | 0                    | –   | $A_{VDD}$            | V       |
| $C_{IN}$                 | Input capacitance            | FS0/1/2 and OE pins only  | –                    | –   | 7                    | pF      |
| $I_{VDD}$                | Supply current               | $V_{DD}/A_{VDD}/V_{DDL}$ current                                    | –                    | 60  | –                    | mA      |
| $C_{INXIN}$              | Input capacitance at XIN     | VCXO disabled external reference                                    | –                    | 15  | –                    | pF      |
| $C_{INXTAL}$             | Input capacitance at crystal | VCXO disabled fixed frequency oscillator                            | –                    | 12  | –                    | pF      |

### Notes

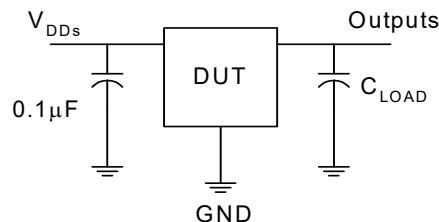
- Parameters are guaranteed by design and characterization. Not 100% tested in production. All parameters specified with fully loaded outputs.
- Custom drive level is available upon request.

## AC Parameters

| Parameter <sup>[4]</sup> | Description                          | Conditions   | Min       | Typ       | Max | Units |
|--------------------------|--------------------------------------|--|-----------|-----------|-----|-------|
| 1/t <sub>1</sub>         | Output frequency                     | PLL <sub>minmax</sub> /Divider <sub>maximum</sub>  | 4.2       | —         | 166 | MHz   |
| DC1                      | Output duty cycle (excluding REFOUT) | Duty cycle is defined in <a href="#">Figure 7</a> ; t <sub>2</sub> /t <sub>1</sub> , 50% of V <sub>DD</sub><br>External reference duty cycle between 40% and 60% measured at V <sub>DD</sub> /2 (Clock output is $\leq$ 125 MHz) | 45        | 50        | 55  | %     |
| DC2                      | Output duty cycle                    | Duty cycle is defined in <a href="#">Figure 7</a> ; t <sub>2</sub> /t <sub>1</sub> , 50% of V <sub>DD</sub><br>External reference duty cycle between 40% and 60% measured at V <sub>DD</sub> /2 (Clock output is $>$ 125 MHz)    | 40        | 50        | 60  | %     |
| DC <sub>REFOUT</sub>     | Output duty cycle                    | Duty cycle is defined in <a href="#">Figure 7</a> ; t <sub>2</sub> /t <sub>1</sub> , 50% of V <sub>DD</sub><br>(XIN Duty Cycle = 45/55%)   | 40        | 50        | 60  | %     |
| ER                       | Rising edge rate                     | Output clock edge rate. Measured from 20% to 80% of V <sub>DD</sub> . C <sub>LOAD</sub> = 15 pF. See <a href="#">Figure 8</a> .  | 0.75      | 1.2       | —   | V/ns  |
| EF                       | Falling edge rate                    | Output clock edge rate. Measured from 80% to 20% of V <sub>DD</sub> . C <sub>LOAD</sub> = 15 pF. See <a href="#">Figure 8</a> .  | 0.75      | 1.2       | —   | V/ns  |
| T <sub>9</sub>           | Clock jitter                         | Period jitter  | —         | $\pm 250$ | —   | ps    |
| T <sub>10</sub>          | PLL lock time                        |  | —         | 1         | 5   | ms    |
| f <sub>ΔXO</sub>         | VCXO crystal pull range              | Using non-SMD-49 crystal<br>Nominal crystal frequency input assumed (0 ppm) at 25 °C and 3.3 V   | $\pm 110$ | $\pm 120$ | —   | ppm   |
|                          |                                      | Using SMD-49 crystal<br>Nominal crystal frequency input assumed (0 ppm) at 25 °C and 3.3 V   | $\pm 105$ | $\pm 120$ | —   | ppm   |

## Test and Measurement

**Figure 6. Test and Measurement**



## Voltage and Timing Definitions

Figure 7. Duty Cycle Definition

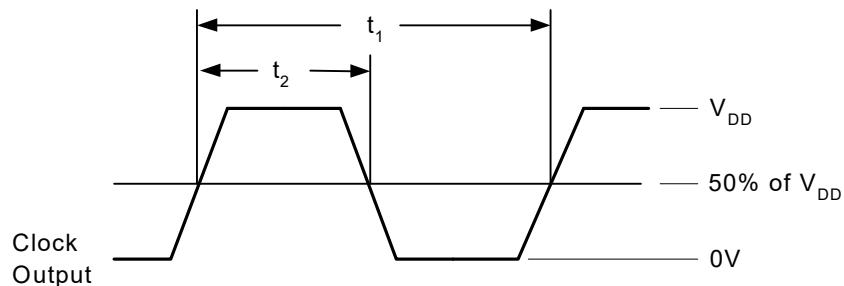


Figure 8.  $ER = (0.6 \times V_{DD})/t_3$ ,  $EF = (0.6 \times V_{DD})/t_4$

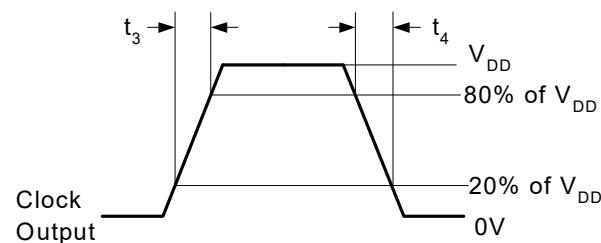
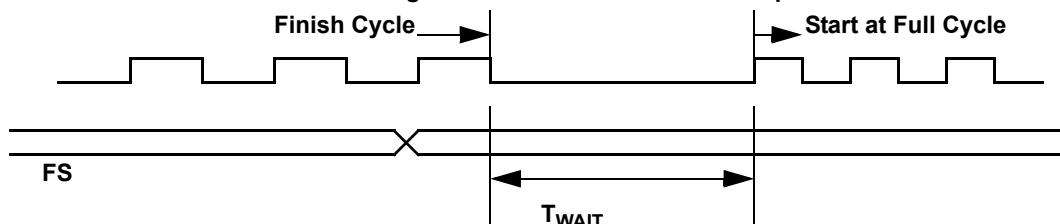


Figure 9. FS Controlled Clock Output



## Ordering Information

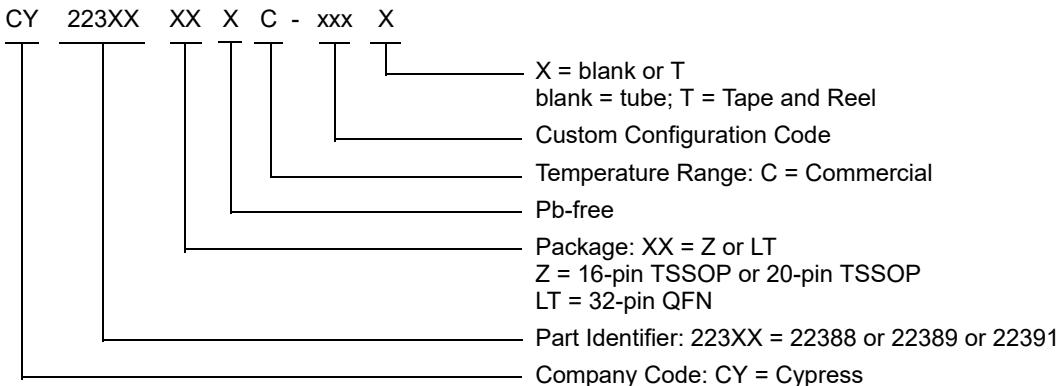
All product offerings are factory-programmed customer-specific devices with customized part numbers. The [Possible Configurations](#) table shows the available device types, but not complete part numbers. Contact your local Cypress FAE or sales representative for more information.

| Part Number    | Package | Type                         | Production Flow            |
|----------------|---------|------------------------------|----------------------------|
| <b>Pb-free</b> |         |                              |                            |
| CY22388FZXC    | ZZ16    | 16-pin TSSOP                 | Commercial, 0 °C to +70 °C |
| CY22388FZXCT   | ZZ16    | 16-pin TSSOP – Tape and Reel | Commercial, 0 °C to +70 °C |

## Possible Configurations

| Part Number <sup>[6]</sup> | Package | Type                              | Production Flow            |
|----------------------------|---------|-----------------------------------|----------------------------|
| <b>Pb-free</b>             |         |                                   |                            |
| CY22388ZXC-xxx             | ZZ16    | 16-pin TSSOP                      | Commercial, 0 °C to +70 °C |
| CY22388ZXC-xxxT            | ZZ16    | 16-pin TSSOP – Tape and Reel      | Commercial, 0 °C to +70 °C |
| CY22389ZXC-xxx             | ZZ20    | 20-pin TSSOP                      | Commercial, 0 °C to +70 °C |
| CY22389ZXC-xxxT            | ZZ20    | 20-pin TSSOP – Tape and Reel      | Commercial, 0 °C to +70 °C |
| CY22391LTXC-xxx            | LT32    | 32-pin QFN (Sawn)                 | Commercial, 0 °C to +70 °C |
| CY22391LTXC-xxxT           | LT32    | 32-pin QFN (Sawn) – Tape and Reel | Commercial, 0 °C to +70 °C |

## Ordering Code Definitions

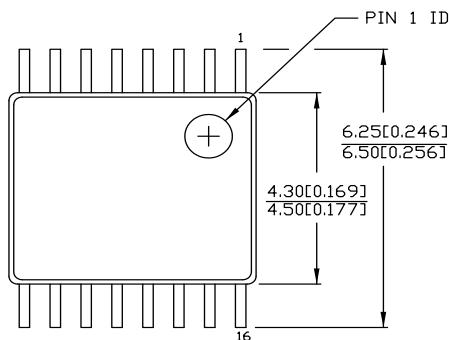


### Note

- The CY22388ZXC-xxx, CY22389ZXC-xxx, and CY22391LTXC-xxx are factory-programmed configurations. For more details, contact your local Cypress FAE or sales representative.

## Package Drawing and Dimensions

Figure 10. 16-pin TSSOP (4.40 mm Body) Package Outline, 51-85091

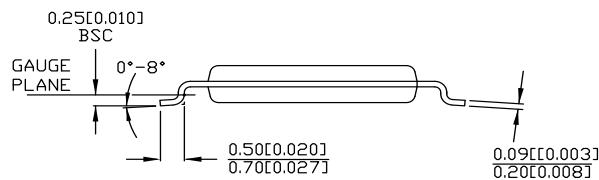
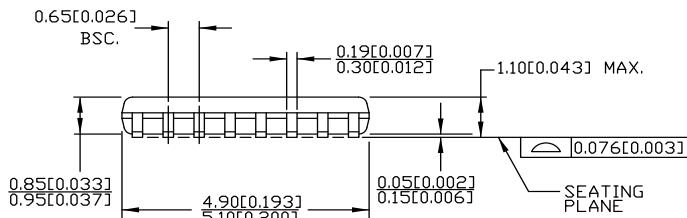


DIMENSIONS IN MM[INCHES] MIN. MAX.

REFERENCE JEDEC MO-153

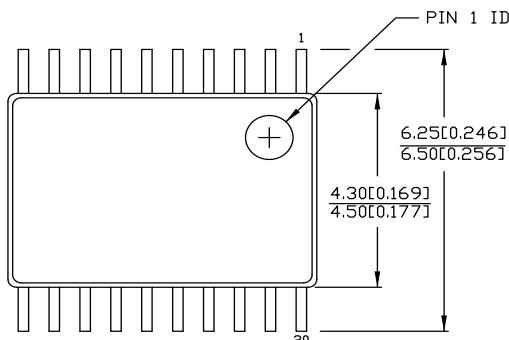
PACKAGE WEIGHT 0.05gms

| PART #   |                |
|----------|----------------|
| Z16.173  | STANDARD PKG.  |
| ZZ16.173 | LEAD FREE PKG. |



51-85091 \*E

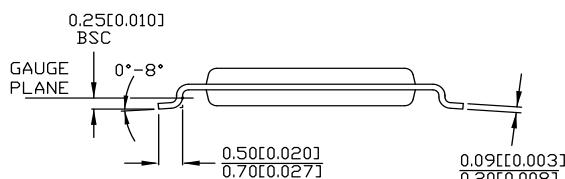
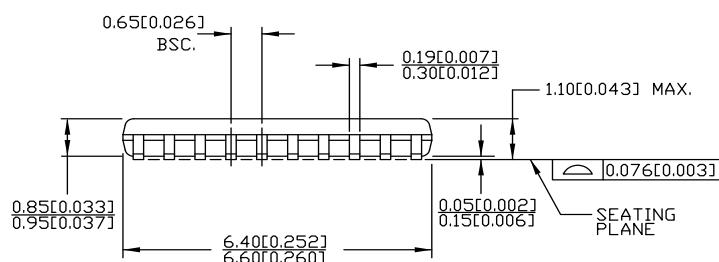
Figure 11. 20-pin TSSOP (4.40 mm Body) Package Outline, 51-85118



DIMENSIONS IN MM[INCHES] MIN. MAX.

REFERENCE JEDEC MO-153

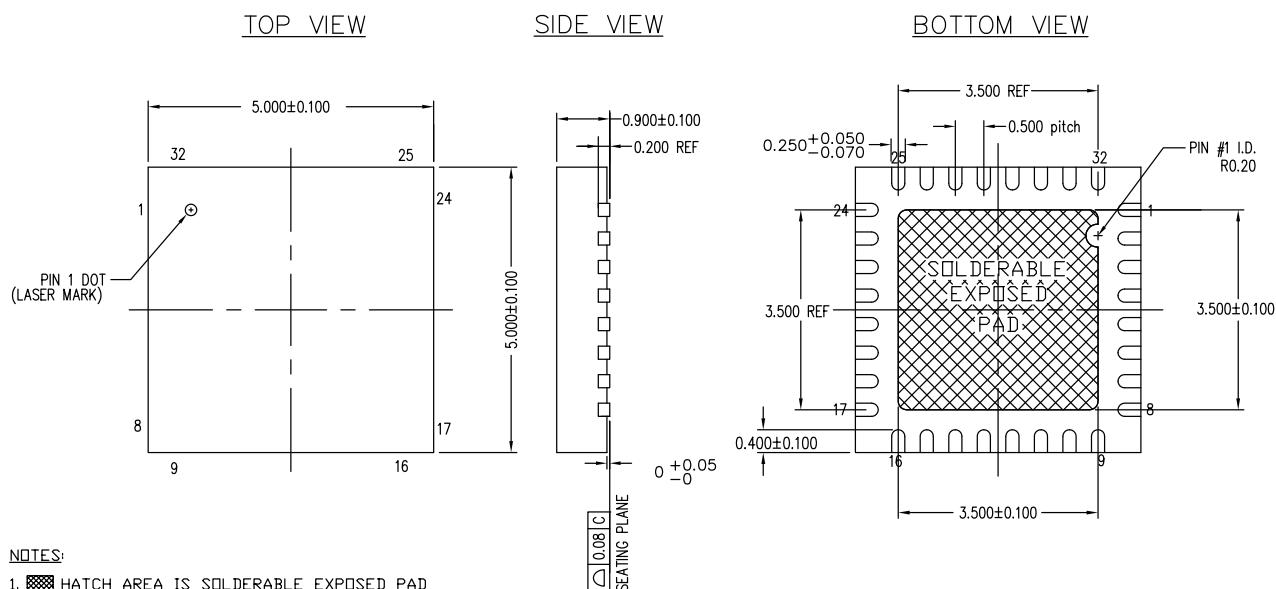
| PART #   |                |
|----------|----------------|
| Z20.173  | STANDARD PKG.  |
| ZZ20.173 | LEAD FREE PKG. |



51-85118 \*E

## Package Drawing and Dimensions (continued)

**Figure 12. 32-pin QFN ((5 x 5 x 1.0 mm) 3.5 x 3.5 E-Pad (Sawn)) Package Outline, 001-30999**



### NOTES:

1. HATCH AREA IS SOLDERABLE EXPOSED PAD
2. BASED ON REF JEDEC # MO-220
3. DIMENSIONS ARE IN MILLIMETERS
4. PACKAGE WEIGHT: SEE CYPRESS PACKAGE MATERIAL DECLARATION  
Datasheet (PMDD) POSTED ON THE CYPRESS WEB

001-30999 \*D

## Acronyms

| Acronym | Description                           |
|---------|---------------------------------------|
| ESD     | Electrostatic Discharge               |
| ESR     | Equivalent Series Resistance          |
| FAE     | Field Application Engineer            |
| FS      | Frequency Select                      |
| PJ      | Period Jitter                         |
| PLL     | Phase-Locked Loop                     |
| QFN     | Quad Flat No-leads                    |
| TSSOP   | Thin Shrunk Small Outline Package     |
| VCO     | Voltage-Controlled Oscillator         |
| VCXO    | Voltage-Controlled Crystal Oscillator |

## Document Conventions

### Units of Measure

| Symbol | Unit of Measure   |
|--------|-------------------|
| °C     | degree Celsius    |
| fF     | femtofarad        |
| KΩ     | kilohm            |
| MHz    | megahertz         |
| µA     | microampere       |
| µF     | microfarad        |
| µs     | microsecond       |
| µW     | microwatt         |
| mA     | milliampere       |
| ms     | millisecond       |
| mV     | millivolt         |
| ns     | nanosecond        |
| Ω      | ohm               |
| PPM    | parts per million |
| pF     | picofarad         |
| ps     | picosecond        |
| V      | volt              |
| W      | watt              |

## Document History Page

Document Title: CY22388/CY22389/CY22391, Factory Programmable, Quad PLL Clock Generator with VCXO  
 Document Number: 38-07734

| Revision | ECN     | Orig. of Change | Submission Date | Description of Change  |
|----------|---------|-----------------|-----------------|--|
| **       | 320458  | RGL             | 03/07/2005      | New data sheet.  |
| *A       | 389649  | RGL             | 08/02/2005      | <p>Updated <a href="#">Pullable Crystal Specifications</a>:<br/>   Removed typical value of R1 parameter.<br/>   Changed maximum value of R1 parameter from <math>50\ \Omega</math> to <math>40\ \Omega</math>.<br/>   Updated details in "Comments" column corresponding to DL parameter.<br/>   Changed maximum value of DL parameter from <math>900\ \mu\text{W}</math> to <math>300\ \mu\text{W}</math>.<br/>   Updated <a href="#">AC Parameters</a>:<br/>   Changed minimum value of <math>f_{\Delta\text{XO}}</math> parameter from <math>\pm 120\ \text{ppm}</math> to <math>\pm 110\ \text{ppm}</math>.<br/>   Changed typical value of <math>f_{\Delta\text{XO}}</math> parameter from blank to <math>\pm 120\ \text{ppm}</math>.</p>  |
| *B       | 523597  | RGL             | 11/12/2006      | <p>Updated <a href="#">AC Parameters</a>:<br/>   Updated details in "Conditions" column corresponding to <math>f_{\Delta\text{XO}}</math> parameter.<br/>   Retained existing values for <math>f_{\Delta\text{XO}}</math> parameter corresponding to Test Condition "Using non-SMD-49 crystal specified in "CY22388 Application Note, ANC0002".<br/>   Added values for <math>f_{\Delta\text{XO}}</math> parameter corresponding to Test Condition "Using SMD-49 crystal specified in "CY22388 Application Note, ANC0002".<br/>   Updated to new template.</p>   |
| *C       | 2632357 | KVM             | 01/13/2009      | <p>Updated Document Title to read as "CY22388, CY22389, CY22391 Factory Programmable Quad PLL Clock Generator with VCXO".<br/>   Updated <a href="#">Logic Block Diagram</a> (Clarified that Power Down (PD#) is active-low).<br/>   Updated <a href="#">Pinouts</a>:<br/>   Updated <a href="#">Figure 2</a> (Replaced PD with PD#).<br/>   Updated <a href="#">Pin Definitions</a>:<br/>   Replaced PD with PD#<br/>   Updated details in "Description" column corresponding to OE/PD# pin.<br/>   Updated <a href="#">DC Parameters</a>:<br/>   Updated details in "Conditions" column corresponding to <math>V_{\text{VCXO}}</math> parameter.<br/>   Updated <a href="#">Ordering Information</a>:<br/>   Updated part numbers.<br/>   Added a column "Package" and added details in that column.<br/>   Added a Note "Not recommended for new designs. The LY32 QFN package transitions to the LT32 QFN." and referred the note in CY22391LFXC-xxx and CY22391LFXC-xxxT.<br/>   Updated <a href="#">Package Drawing and Dimensions</a>:<br/>   spec 51-85188 – Changed revision from *A to *B.<br/>   Updated to new template.</p> |
| *D       | 2897246 | KVM             | 03/22/2010      | <p>Updated <a href="#">Ordering Information</a>:<br/>   Added description (Regarding Possible Configurations).<br/>   Updated <a href="#">Possible Configurations</a>:<br/>   Updated part numbers.<br/>   Updated Note 6.<br/>   Removed Note "Not recommended for new designs. The LY32 QFN package transitions to the LT32 QFN."<br/>   Updated <a href="#">Package Drawing and Dimensions</a>:<br/>   51-85091 – Changed revision from *A to *B.<br/>   51-85118 – Changed revision from *A to *B.<br/>   001-30999 – Changed revision from *A to *C.<br/>   Removed spec 51-85188 *B.</p>   |

**Document History Page** (continued)

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**Document Number:** 38-07734

| Revision | ECN     | Orig. of Change | Submission Date | Description of Change  |
|----------|---------|-----------------|-----------------|--|
| *E       | 3030336 | CXQ             | 09/14/2010      | <p>Fixed various typos across the document.</p> <p>Updated <a href="#">Features</a>:</p> <p>Fixed formatting.</p> <p>Updated <a href="#">Absolute Maximum Conditions</a>:</p> <p>Updated value of MSL parameter as 3 for all packages.</p> <p>Updated <a href="#">Operating Conditions</a>:</p> <p>Removed "Recommended" from heading.</p> <p>Updated <a href="#">Ordering Information</a>:</p> <p>No change in part numbers.</p> <p>Added <a href="#">Ordering Code Definitions</a>.</p> <p>Updated <a href="#">Package Drawing and Dimensions</a>:</p> <p>spec 51-85091 – Changed revision from *B to *C.</p> <p>spec 51-85118 – Changed revision from *B to *C.</p> <p>Added <a href="#">Acronyms</a> and <a href="#">Units of Measure</a>.</p> <p>Updated to new template.</p> |
| *F       | 3786734 | PURU            | 10/29/2012      | <p>Updated <a href="#">Pinouts</a>:</p> <p>Updated <a href="#">Figure 3</a> (Updated caption only).</p> <p>Updated <a href="#">Ordering Information</a>:</p> <p>Updated part numbers (Added two part numbers (CY22388FZXC and CY22388FZXCT)).</p> <p>Updated <a href="#">Package Drawing and Dimensions</a>:</p> <p>spec 51-85091 – Changed revision from *C to *D.</p> <p>spec 51-85118 – Changed revision from *C to *D.</p> <p>spec 001-30999 – Changed revision from *C to *D.</p>   |
| *G       | 4142797 | CINM            | 10/01/2013      | <p>Updated to new template.</p> <p>Completing Sunset Review.</p>   |
| *H       | 4576237 | CINM            | 11/21/2014      | <p>Updated <a href="#">Features</a>:</p> <p>Updated output frequency range as 1 MHz to 166 MHz.</p> <p>Updated <a href="#">Functional Description</a>:</p> <p>Added "For a complete list of related documentation, click <a href="#">here</a>." at the end.</p> <p>Updated <a href="#">Package Drawing and Dimensions</a>:</p> <p>spec 51-85091 – Changed revision from *D to *E.</p> <p>spec 51-85118 – Changed revision from *D to *E.</p>   |
| *I       | 5475432 | XHT             | 10/14/2016      | <p>Updated to new template.</p> <p>Completing Sunset Review.</p>   |
| *J       | 5995535 | AESATMP8        | 12/15/2017      | Updated Cypress Logo and Copyright.  |
| *K       | 6520812 | XHT             | 03/25/2019      | <p>Updated <a href="#">Analog VCXO</a>:</p> <p>Updated description.</p> <p>Updated <a href="#">Pullable Crystal Specifications</a>:</p> <p>Updated Note 2.</p> <p>Updated <a href="#">AC Parameters</a>:</p> <p>Updated details in "Conditions" column corresponding to <math>f_{\Delta XO}</math> parameter.</p> <p>Updated to new template.</p>  |

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